

Octal D-Type Flip-Flop with Clear

MM74HCT273

General Description

The MM74HCT273 utilizes advanced silicon-gate CMOS technology. It has an input threshold and output drive similar to LS-TTL with the low standby power of CMOS.

These positive edge-triggered flip-flops have a common clock and clear-independent Q outputs. Data on a D input, having the specified set-up and hold time, is transferred to the corresponding Q output on the positive-going transition of the clock pulse. The asynchronous clear forces all outputs LOW when it is LOW.

All inputs to this device are protected from damage due to electrostatic discharge by diodes to V_{CC} and ground.

MM74HCT devices are intended to interface TTL and NMOS components to CMOS components. These parts can be used as plug-in replacements to reduce system power consumption in existing designs.

Features

- Typical Propagation Delay: 18 ns
- Low Quiescent Current: 160 μ A Maximum (74HCT Series)
- Fanout of 10 LS-TTL Loads
- This is a Pb-Free Device

Connection Diagram

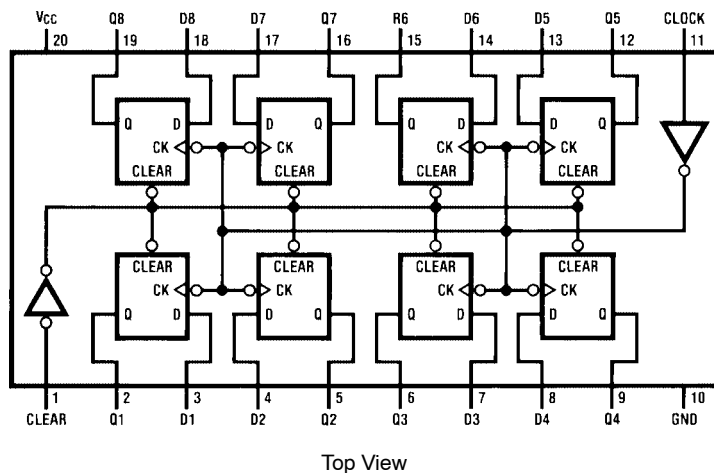
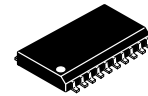
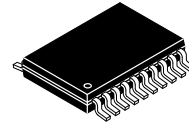


Figure 1. Pin Assignments for SOIC and TSSOP

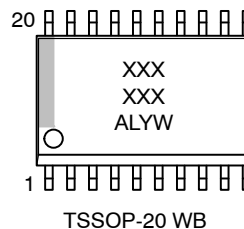
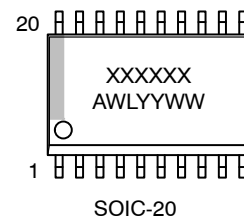


SOIC-20 WB
CASE 751D-05



TSSOP-20 WB
CASE 948E

MARKING DIAGRAM



XXXXXX = Specific Device Code
A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week

ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

MM74HCT273

TRUTH TABLE (Each Flip-Flop)

Inputs			Outputs
Clear	Clock	D	Q
L	X	X	L
H	↑	H	H
H	↑	L	L
H	L	X	Q0

NOTE: H = HIGH Level (steady-state)

L = LOW Level (steady-state)

X = Don't Care

↑ = Transition from LOW-to-HIGH level

Q0 = The level of Q before the indicated steady-state input conditions were established.

Logic Diagram

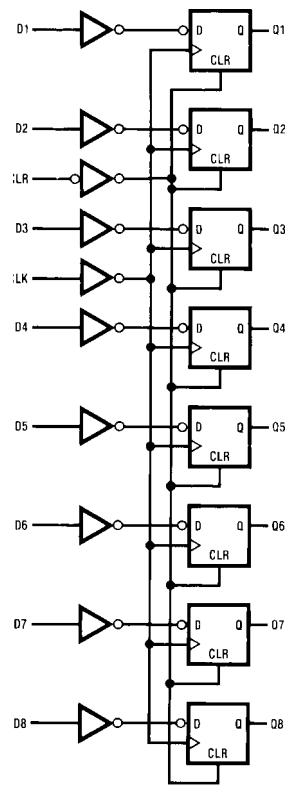


Figure 2. Logic Diagram

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ABSOLUTE MAXIMUM RATINGS (Note 1)

Symbol	Parameter	Rating	Unit
V_{CC}	Supply Voltage	-0.5 to +6.5	V
V_{IN}	DC Input Voltage	-0.5 to $V_{CC} + 0.5$	V
V_{OUT}	DC Output Voltage	-0.5 to $V_{CC} + 0.5$	V
I_{IK}, I_{OK}	Clamp Diode Current	± 20	mA
I_{OUT}	DC Output Current, per Pin	± 25	mA
I_{CC}	DC V_{CC} or GND Current, per Pin	± 50	mA
T_{STG}	Storage Temperature Range	-65 to +150	°C
P_D	Power Dissipation SOIC TSSOP	1302 833	mW
T_L	Lead Temperature (Soldering 10 Seconds)	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Unless otherwise specified all voltages are referenced to ground.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V_{CC}	Supply Voltage	4.5	5.5	V
V_{IN}, V_{OUT}	DC Input or Output Voltage	0	V_{CC}	V
T_A	Operating Temperature Range	-55	+125	°C
t_r, t_f	Input Rise or Fall Times		500	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

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DC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5\text{ V} \pm 10\%$, unless otherwise specified)

Symbol	Parameter	Conditions	T _A = 25°C		T _A = -40 °C to 85 °C	T _A = -55 °C to 125 °C	Unit
			Typ	Guaranteed Limits			
V _{IH}	Minimum HIGH Level Input Voltage		–	2.0	2.0	2.0	V
V _{IL}	Maximum LOW Level Input Voltage		–	0.8	0.8	0.8	V
V _{OH}	Minimum HIGH Level Output Voltage	V _{IN} = V _{IH} or V _{IL} I _{OUT} = 20 μA	V _{CC}	V _{CC} – 0.1	V _{CC} – 0.1	V _{CC} – 0.1	V
		V _{IN} = V _{IH} or V _{IL} I _{OUT} = 4.0 mA, V _{CC} = 4.5 V	4.2	3.98	3.84	3.7	V
		V _{IN} = V _{IH} or V _{IL} I _{OUT} = 4.8 mA, V _{CC} = 5.5 V	5.2	4.98	4.84	4.7	V
V _{OL}	Minimum LOW Level Voltage	V _{IN} = V _{IH} or V _{IL} I _{OUT} = 20 μA	0	0.1	0.1	0.1	V
		V _{IN} = V _{IH} or V _{IL} I _{OUT} = 4.0 mA, V _{CC} = 4.5 V	0.2	0.26	0.33	0.4	V
		V _{IN} = V _{IH} or V _{IL} I _{OUT} = 4.8 mA, V _{CC} = 5.5 V	0.2	0.26	0.33	0.4	V
I _{IN}	Maximum Input Current	V _{IN} = V _{CC} or GND, V _{IH} or V _{IL}	–	±0.1	±1.0	±1.0	μA
I _{CC}	Maximum Quiescent Supply Current	V _{IN} = V _{CC} or GND, I _{OUT} = 0 μA	–	8	80	160	μA
		V _{IN} = 2.4 V or 0.5 V (Note 2)	–	1.2	1.4	1.5	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Measured per pin, all other inputs held at V_{CC} or GND.

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AC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5\text{ V}$, $T_A = 25\text{ }^{\circ}\text{C}$, $C_L = 15\text{ pF}$, $t_r = t_f = 6\text{ ns}$)

Symbol	Parameter	Conditions	Typ	Guaranteed Limit	Unit
f_{MAX}	Maximum Operating Frequency		68	30	MHz
t_{PHL} , t_{PLH}	Maximum Propagation Delay from Clock to Q		18	30	ns
t_{PHL} , t_{PLH}	Maximum Propagation Delay from Clear to Q		21	30	ns
t_{REM}	Minimum Removal Time, Clear to Clock		-1	5	ns
t_S	Minimum Set-Up Time D to Clock		6	20	ns
t_H	Minimum Hold Time Clock to D		-3	5	ns
t_W	Minimum Pulse Width Clock or Clear		10	16	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0\text{ V} \pm 10\%$, $C_L = 50\text{ pF}$, $t_r = t_f = 6\text{ ns}$ (unless otherwise specified))

Symbol	Parameter	Conditions	T _A = 25 °C		T _A = −40 °C to 85 °C	T _A = −55 °C to 125 °C	Unit
			Typ	Guaranteed Limits			
f _{MAX}	Maximum Operating Frequency		68	27	21	18	MHz
t _{PHL} , t _{PLH}	Maximum Propagation Delay from Clock to Q		22	37	46	56	ns
t _{PHL} , t _{PLH}	Maximum Propagation Delay from Clear to Q		25	35	44	52	ns
t _{REM}	Minimum Removal Time Clear to Clock		−1	5	6	7	ns
t _S	Minimum Set-Up Time D to Clock		6	20	25	30	ns
t _H	Minimum Hold Time Clock to D		−3	5	5	5	ns
t _W	Minimum Pulse Width Clock or Clear		10	16	25	30	ns
t _r , t _f	Maximum Input Rise and Fall Time, Clock		–	500	500	500	ns
t _{THL} , t _{TLH}	Maximum Output Rise and Fall Time		11	15	19	22	ns
C _{PD}	Power Dissipation Capacitance (Note 3)	(Per Flip-Flop)	50	–	–	–	pF
C _{IN}	Maximum Input Capacitance		6	10	10	10	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC}^2 f + I_{CC}$.

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ORDERING INFORMATION

Part Number	Marking	Package	Shipping [†]
MM74HCT273WM	HCT273A	SOIC-20 WB, Case 751D-05 (Pb-Free and Halide-Free)	38 Units / Tube
MM74HCT273WMX	HCT273A		1000 / Tape & Reel
MM74HCT273MTC	HCT 273A	TSSOP-20 WB, Case 948E (Pb-Free)	75 Units / Tube
MM74HCT273MTCX	HCT 273A		2500 / Tape & Reel

[†] For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).



SCALE 1:1

SOIC-20 WB
CASE 751D-05
ISSUE H

DATE 22 APR 2015



NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS	
	MIN	MAX
A	2.35	2.65
A1	0.10	0.25
b	0.35	0.49
c	0.23	0.32
D	12.65	12.95
E	7.40	7.60
e	1.27 BSC	
H	10.05	10.55
h	0.25	0.75
L	0.50	0.90
θ	0°	7°

RECOMMENDED
SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC
MARKING DIAGRAM*



XXXXXX = Specific Device Code
A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week
G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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